

ICAMC 2025

2025 **11th** International Conference on
Architecture, Materials and Construction

September 3-5, 2025

Meijo University
NAGOYA, JAPAN



CALL

For

Papers

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Conference Dates: September 3-5, 2025

Venue: Nagoya, Japan

Website: www.icamc.org

Conference Committees

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Conference Co-Chairs

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<https://www.icamc.org/com.html>

ICAMC Conference Secretary:

Ms. Rachel Liu

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Working Time: Monday - Friday 9:30-18:00

Publication

Scientific.Net collection:

Materials Science Forum (MSF)

Key Engineering Materials (KEM)

Solid State Phenomena (SSP)

Defect and Diffusion Forum (DDF)

Topics

Civil and Structural Engineering

Architecture and Urban Planning

Materials Manufacturing and Processing

...

For more detailed information about the

conference topics: <https://www.icamc.org/cfp.html>

Submission

*Online System:

<https://confsys.iconf.org/submission/icamc2025>

*By Email: icamc@cbees.net

For paper templates and more information:

<https://www.icamc.org/sub.html...>

2025 Speakers



Prof. Qing Wang

Taishan University, China



Prof. Ariya Aruninta

Chulalongkorn University, Thailand

Publication History

ICAMC 2024 ☆ Advances in Science and Technology
(Vol. 159)

ICAMC 2023 ☆ Advances in Science and Technology
(Vol. 137)

ICAMC 2022 ☆ Materials Today: Proceedings-Volume 85

ICAMC 2021 ☆ Springer-Lecture Notes in Civil
Engineering

ICAMC 2020 ☆ IOP Conference Series: Materials Science
and Engineering (Vol. 1044)

ICAMC 2019 ☆ IOP Conference Series: Materials Science
and Engineering (Vol. 809)

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